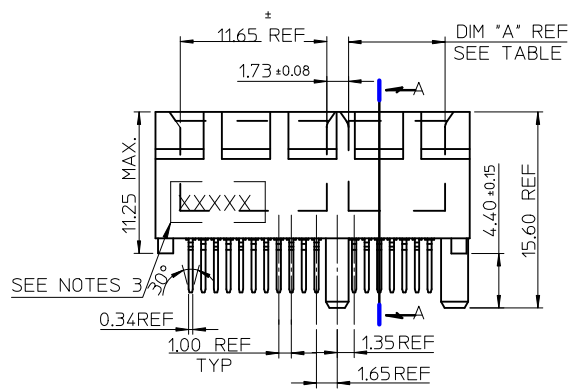
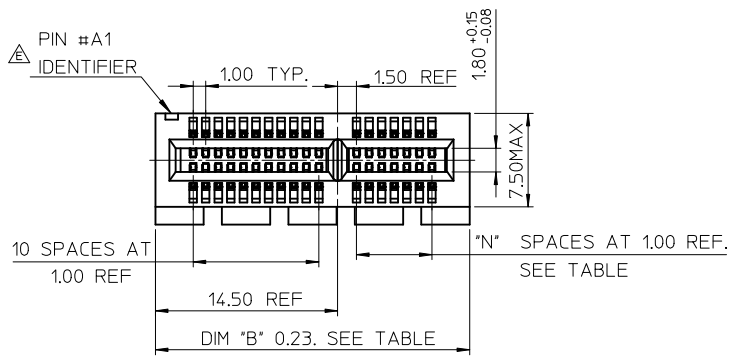
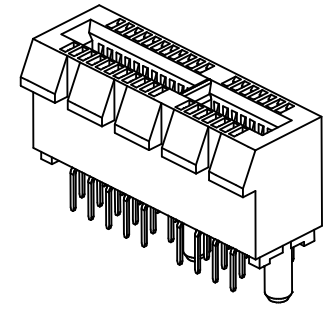
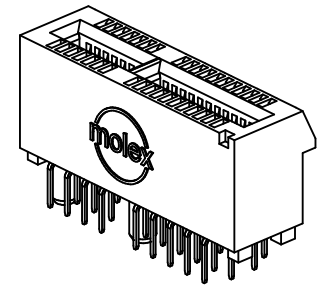
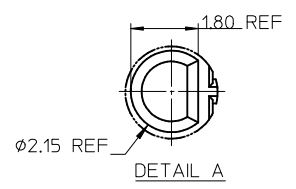


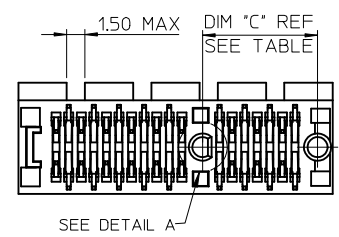
SECTION A-A



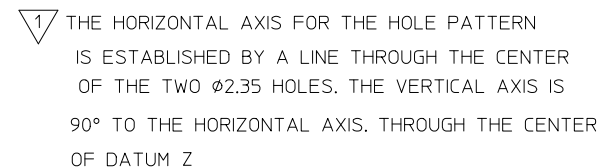
- NOTES:
- 1.MATERIALS:
- 1-1.HOUSING: SEE TABLE ,GLASS FIBER FILLED UL94V-0, COLOR: SEE TABLE.
 - 1-2.CONTACT: SEE TABLE
- 2.PLATING:
- 2-1.CONTACT AREA: GOLD, THICKNESS : SEE TABLE .
 - 2-2.SOLDER TAIL: 100 MICRINCH MIN. TIN PLATING.
 - 2-3.UNDER PLATING: NICKEL PLATING OVERALL.
- 3.WEEK CODE: XX(YEAR) XX(WEEK) X(LOCATION).
- 4.PRODUCT SPECIFICATION REFER TO PS-87715-200.
- 5.PACKAGING SPECIFICATION REFER TO PK-87715-207.
- 6.TEST SUMMARY:REFER TO TS-87715-207.
- 7.LEAD FREE AND ROHS COMPLIANCE PRODUCT.

CONNECTOR LINK WIDTH	# POS REF	N	DIM 'A' REF	DIM 'B' REF	DIM 'C' REF
X1	36	6	7.65	25.00	9.15
X4	64	20	21.65	39.00	23.15
X8	98	37	38.65	56.00	40.15
X16	164	70	71.65	89.00	73.15

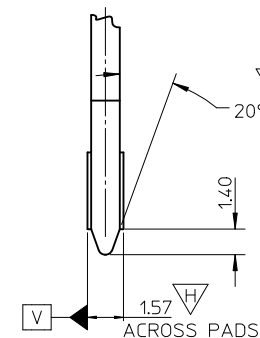
PCB THK (REF)	DIM 'D' REF
1.60	2.30
1.58	2.54
2.36	3.00



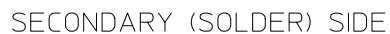
REVISED EC NO: SH2010-0468 DRWNRZhang CHKD: ALLEN LIN APPR: XJ.SONG	DESCRIPTION REV	QUALITY SYMBOLS F=0 F=0 F=0	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION		
			mm	INCH	DRAWN BY TOM	DATE 2004/07/20	TITLE				
		4 PLACES	± ---	± ---	CHECKED BY ALLEN LIN	DATE 2004/07/20	PCI EXPRESS EDGE CARD CONNECTOR (LEAD FREE VERSION) MOLEX INCORPORATED				
		3 PLACES	± ---	± ---	APPROVED BY WILSON	DATE 2004/07/20					
		2 PLACES	± 0.25	± ---	MATERIAL NO.		DOCUMENT NO.				
1 PLACE	± 0.25	± ---	ANGULAR ± 3 °		SEE SHEET 4						
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS			SIZE A3		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION						



SEE SHEET 1	EC NO: SH2010-0468 DRAWN:ZHANG CHKD:ALLEN APPR:XJSONG	2010/06/15 2010/07/20	DESCRIPTION	QUALITY SYMBOLS FA=0 FB=0 FC=0	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE		SCALE	DESIGN UNITS	THIRD ANGLE PROJECTION		
							MM ONLY			METRIC			
							DRAWN BY		DATE			TITLE	
							CHECKED BY		DATE			PCI EXPRESS EDGE CARD CONNECTOR (LEAD FREE VERSION)	
							APPROVED BY		DATE			MOLEX MOLEX INCORPORATED	
I	REV				ANGULAR ± 3 °		WILSON		2004/07/20		DOCUMENT NO. SD-87715-207	SHEET NO. 2 OF 4	
					DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		MATERIAL NO. SEE SHEET 4						
						SIZE A3	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION						



PRIMARY (COMPONENT) SIDE



3. TOLERANCE: .XX±.13

CONNECTOR LINK WIDTH	# POS REF	N	DIM 'B'	'C' 
X1	36	6	8.15	B17
X4	64	20	22.15	B17, B31
X8	98	37	39.15	B17, B31 B48
X16	164	70	72.15	B17, B31 B48, B81

SEE SHEET 1 EC NO: SH2010-0468 DRWN:RZHANG CHKD:ALLEN LIN APPR:XJ SONG	2010/06/15 2004/07/20 2010/07/02	DESCRIPTION	QUALITY SYMBOLS ▽_A =0 ▽_C =0 ▽_P =0	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE		SCALE	DESIGN UNITS	THIRD ANGLE PROJECTION			
						MM ONLY			METRIC				
					mm	INCH	DRAWN BY	DATE	TITLE PCI EXPRESS EDGE CARD CONNECTOR (LEAD FREE VERSION)				
				4 PLACES	± ---	± ---	TOM	2004/07/20					
				3 PLACES	± ---	± ---	CHECKED BY	DATE					
				2 PLACES	± 0.25	± ---	ALLEN LIN	2004/07/20					
					1 PLACE	± 0.25	± ---	APPROVED BY	DATE	molex MOLEX INCORPORATED			
						ANGULAR ± 3 °	WILSON	2004/07/20					
				DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS				MATERIAL NO.		DOCUMENT NO.		SHEET NO.	
								SEE SHEET 4		SD-87715-207		3 OF 4	
				SIZE	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION								
				A3									

F

F

E

E

D

D

C

C

B

B

A

A

▽H

MOLEX P/N	CIRCUIT SIZE	HOUSING MATERIAL	HOUSING COLOR	TERMINAL MATERIAL	CONTACT PLATING	SOLDER TAIL 'D' LENGTH
87715-9001	36	NYLON46	BLACK	PHOSPHOR BRONZE	10 MICROINCH	2.54
87715-9003					GOLD FLASH	3.00
87715-9004					10 MICROINCH	
87715-9007					GOLD FLASH	
87715-9008					15 MICROINCH	2.30

MOLEX P/N	CIRCUIT SIZE	HOUSING MATERIAL	HOUSING COLOR	TERMINAL MATERIAL	CONTACT PLATING	SOLDER TAIL 'D' LENGTH
87715-9100	64	NYLON46	BLACK	PHOSPHOR BRONZE	GOLD FLASH	2.54
87715-9101					10 MICROINCH	
87715-9102					15 MICROINCH	3.00
87715-9103					GOLD FLASH	
87715-9104					10 MICROINCH	
87715-9105					15 MICROINCH	2.54
87715-9106					30 MICROINCH	
87715-9107					GOLD FLASH	2.30
87715-9108					15 MICROINCH	3.00
87715-9109					30 MICROINCH	

MOLEX P/N	CIRCUIT SIZE	HOUSING MATERIAL	HOUSING COLOR	TERMINAL MATERIAL	CONTACT PLATING	SOLDER TAIL 'D' LENGTH
87715-9200	98	NYLON46	BLACK	PHOSPHOR BRONZE	GOLD FLASH	2.54
87715-9201					10 MICROINCH	
87715-9202					15 MICROINCH	3.00
87715-9203					GOLD FLASH	
87715-9204					10 MICROINCH	
87715-9205					15 MICROINCH	2.54
87715-9206					30 MICROINCH	
87715-9207					GOLD FLASH	2.30
87715-9208					15 MICROINCH	3.00
87715-9209					30 MICROINCH	

MOLEX P/N	CIRCUIT SIZE	HOUSING MATERIAL	HOUSING COLOR	TERMINAL MATERIAL	CONTACT PLATING	SOLDER TAIL 'D' LENGTH
87715-9602	98	NYLON46	BLACK	BRASS	15 MICROINCH	2.54

▽H

MOLEX P/N	CIRCUIT SIZE	HOUSING MATERIAL	HOUSING COLOR	TERMINAL MATERIAL	CONTACT PLATING	SOLDER TAIL 'D' LENGTH
87715-9301	164	NYLON46	BLACK	PHOSPHOR BRONZE	10 MICROINCH	2.54
87715-9304					GOLD FLASH	3.00
87715-9307						2.30
87715-9308					15 MICROINCH	

SEE SHEET 1

EC NO: SH2010-0468

DRWNR:ZHANG

CHKD:ALLEN LIN

APPR:XJ.SONG

2010/06/15

2004/07/20

2010/07/02

QUALITY SYMBOLS

▽_A=0

▽_C=0

▽_P=0

GENERAL TOLERANCES (UNLESS SPECIFIED)

	mm	INCH
4 PLACES	± ---	± ---
3 PLACES	± ---	± ---
2 PLACES	± 0.25	± ---
1 PLACE	± 0.25	± ---

ANGULAR ± 3 °

DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS

DIMENSION STYLE

MM ONLY

DRAWN BY	DATE
TOM	2004/07/20
CHECKED BY	DATE
ALLEN LIN	2004/07/20
APPROVED BY	DATE
WILSON	2004/07/20

MATERIAL NO.

SEE TABLE

SIZE

A3

THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION

SCALE

DESIGN UNITS

METRIC

THIRD ANGLE PROJECTION

PCI EXPRESS

EDGE CARD CONNECTOR

(LEAD FREE VERSION)

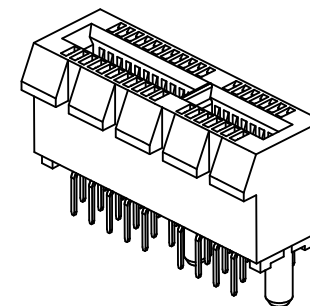
MOLEX INCORPORATED

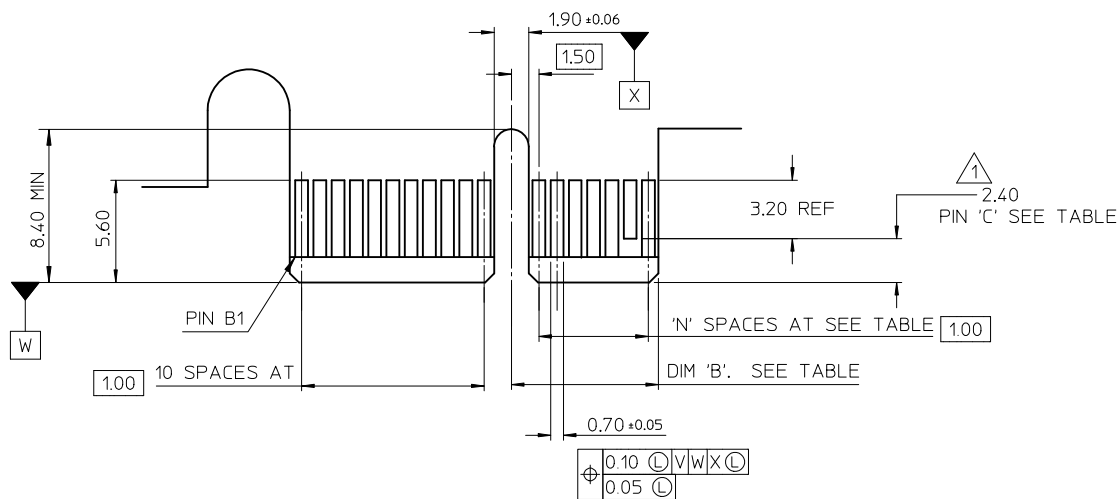
DOCUMENT NO.

SD-87715-207

SHEET NO.

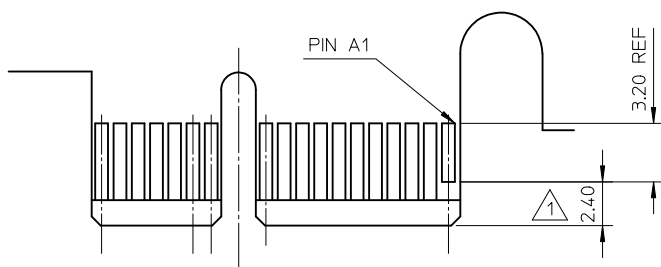
4 OF 4





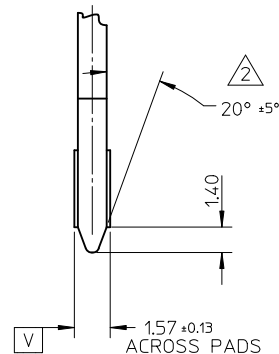
← I/O PANEL DIRECTION

PRIMARY (COMPONENT) SIDE



I/O PANEL DIRECTION →

SECONDARY (SOLDER) SIDE



- 1 NO TIE BAR PERMITTED FROM CARD EDGE TO LEADING EDGE OF PAD FOR PINS A1 AND "C".
- 2 CHAMFER EDGES MUST BE FREE OF CUTTING BURRS.
- 3 TOLERANCE: .XX±.13

CONNECTOR LINK WIDTH	# POS REF	N	DIM 'B'	'C' 1
X1	36	6	8.15	B17
X16	164	70	72.15	B17, B31 B48,B81

QUALITY SYMBOLS		GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE		SCALE	DESIGN UNITS	THIRD ANGLE PROJECTION	
				MM ONLY					
				mm	INCH	DRAWN BY	DATE	TITLE	
				4 PLACES	± ---	DAVID HU	2007/05/14	PCI EXPRESS	
				3 PLACES	± ---	CHECKED BY	DATE	EDGE CARD CONNECTOR	
				2 PLACES	± 0.25	HARVEY	2007/05/14	(LEAD FREE VERSION)	
				1 PLACE	± 0.25	APPROVED BY	DATE	MOLEX INCORPORATED	
						JENNY CHEN	2007/05/14		
						MATERIAL NO.		DOCUMENT NO.	
						SEE SHEET 1		SD-87715-901	
						SIZE		SHEET NO.	
						A3		3 OF 4	



MOLEX P/N	CIRCUIT SIZE	HOUSING MATERIAL	HOUSING COLOR	TERMINAL MATERIAL	CONTACT PLATING	SOLDER TAIL 'D' LENGTH	PEG 1	PEG 2	DESCRIPTION
87715-9000	36	NYLON46	BLACK	PHOSPHOR BRONZE	GOLD FLASH	2.54	WITH	WITH	TOOLED
87715-9002					15 MICROINCH				
87715-9005					15 MICROINCH	3.00			
87715-9006					30 MICROINCH	2.54			
87715-9009					30 MICROINCH	3.00			



MOLEX P/N	CIRCUIT SIZE	HOUSING MATERIAL	HOUSING COLOR	TERMINAL MATERIAL	CONTACT PLATING	SOLDER TAIL 'D' LENGTH	PEG 1	PEG 2	DESCRIPTION
87715-9300	164	NYLON46	BLACK	PHOSPHOR BRONZE	GOLD FLASH	2.54	WITH	WITH	TOOLED
87715-9302					15 MICROINCH				
87715-9303					GOLD FLASH	3.00			
87715-9305					15 MICROINCH				
87715-9306					30 MICROINCH	2.54			
87715-9309					30 MICROINCH	3.00			

SEE SHEET 1

EC NO: SH2011-0358

DRWN:FYANG05

CHKD:

APPR:RZHANG

2011/06/02

2011/06/07

QUALITY SYMBOLS

$F_A=0$

$F_C=0$

$F_P=0$

GENERAL TOLERANCES (UNLESS SPECIFIED)

	mm	INCH
4 PLACES	$\pm$ ---	$\pm$ ---
3 PLACES	$\pm$ ---	$\pm$ ---
2 PLACES	$\pm$ 0.25	$\pm$ ---
1 PLACE	$\pm$ 0.25	$\pm$ ---

ANGULAR $\pm$ 3 °

DRAFT WHERE APPLICABLE
MUST REMAIN
WITHIN DIMENSIONS

DIMENSION STYLE

MM ONLY

DRAWN BY	DATE
DAVID HU	2007/05/14
CHECKED BY	DATE
HARVEY	2007/05/14
APPROVED BY	DATE
JENNY CHEN	2007/05/14

MATERIAL NO.

SEE SHEET 1

SIZE
A3

THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION

SCALE

DESIGN UNITS

METRIC

THIRD ANGLE PROJECTION

TITLE

PCI EXPRESS
EDGE CARD CONNECTOR
(LEAD FREE VERSION)

MOLEX INCORPORATED

DOCUMENT NO.

SD-87715-901

SHEET NO.

4 OF 4

Данный компонент на территории Российской Федерации

Вы можете приобрести в компании MosChip.

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

Офис по работе с юридическими лицами:

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Телефон: +7 495 668-12-70 (многоканальный)

Факс: +7 495 668-12-70 (доб.304)

E-mail: info@moschip.ru

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moschip.ru_9